

# 514-AG11D × OBSOLETE

TE Internal #: 2-1437531-0

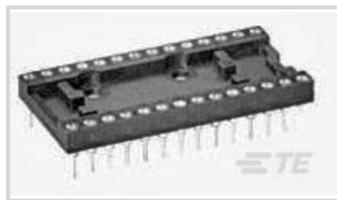
TE Internal Description: 514-AG11D=SOCKET ASSY

DIP Socket: Standard, Stamped & Formed, Closed, Gold

[View on TE.com >](#)



Connectors > Socket Connectors > IC Sockets > DIP Sockets > DIP Socket: Standard, Stamped & Formed, Closed, Gold



Contact Fabrication: **Stamped & Formed**

Number of Positions: **14**

Connector Profile: **Standard**

Row-to-Row Spacing: **7.62 mm [ .3 in ]**

Leg Style: **Straight**

[All DIP Socket: Standard, Stamped & Formed, Closed, Gold \(0\)](#)

## Features

### Product Type Features

Leg Style	Straight
Connector & Contact Terminates To	Printed Circuit Board

### Configuration Features

PCB Mount Orientation	Vertical
Number of Positions	14

### Body Features

Frame Style	Closed
Connector Profile	Standard

### Contact Features

Contact Fabrication	Stamped & Formed
Contact Mating Area Plating Material	Gold
	25 µin
Contact Current Rating (Max)	3 A

### Termination Features

Termination Method to Printed Circuit Board	Through Hole - Solder
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### Mechanical Attachment

Connector Mounting Type	Board Mount
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### Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
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### Dimensions

Row-to-Row Spacing	7.62 mm[.3 in]
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### Usage Conditions

Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
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### Operation/Application

Circuit Application	Signal
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## Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (13% in Component Part) <b>Article Safe Usage Statements:</b> Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Documents



**Product Drawings**

[514-AG11D=SOCKET ASSY](#)

English

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**Datasheets & Catalog Pages**

[DIP Sockets Quick Reference Guide \(EN\)](#)

English

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**Product Environmental Compliance**

[Product Compliance](#)

English

[Product Compliance](#)

English